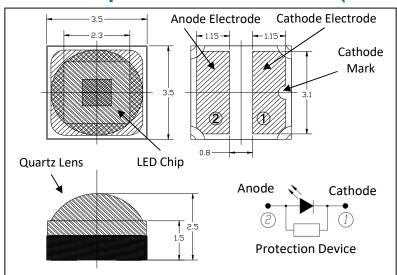






MODEL 325-FL-02-G02 3.5 x 3.5mm Metal Sealed SMD Hemispherical Lens Type

Mechanical Specifications and Materials (Unit: mm)





Typical Optical-Electrical Characteristics

 $(I_F=350mA, T_a=25^{\circ}C)$

ltem	Symbol	Unit	325-FL-02-G02		
			Min	Тур	Max
Peak Wavelength(*)	λ_{p}	nm	320	325	330
Radiant Flux(**)	Po	mW	29	45	-
Full Width at Half Maximum	⊿λ	nm	1	15	20
Forward voltage	V_{F}	\	-	5.0	-
Viewing Half Angle	2 _{0 1/2}	deg.	-	65	-

(*)Peak Wavelength Measurement tolerance is ±3nm.

(**)Radiant Flux Measurement tolerance is ±10%.

(***)Junction-ambient

Specification and dimension are subject to change for improvement without notice.

Binning is available.



WARNING

- · LEDs emit very strong UV radiation.
- Do not look at the LED light with the naked eye or irradiate the skin.

UV radiation can harm your eyes and skin.

- To prevent UV radiation exposure, wear protective eyewear and protective equipment.
- If LEDs are embedded in devices, please indicate warning labels against the UV light LED used.
- Keep out of reach of children.



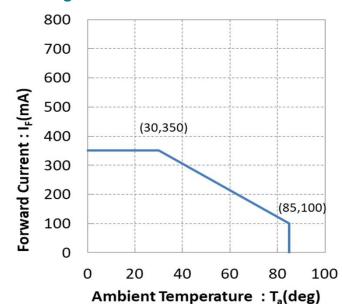
MODEL 325-FL-02-G02

3.5 x 3.5mm Metal Sealed SMD Hemispherical Lens Type

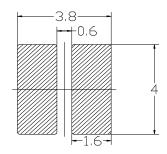
Absolute Maximum Ratings

ltem	Symbol	Unit	Value
Forward Current	I _F	mA	350
Junction Temperature	T_J	°C	90
Operating Temperature	T _{OPR}	လူ	-30 ~ +85
Storage Temperature	T _{STR}	°C	-40 ~ +85 (No condensation)

Derating Curve

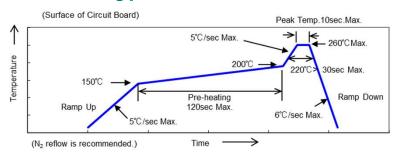


Recommended solder pad



Unit : mm

Reflow soldering profile



This soldering profile is according to JEDEC-J-STD-020D.



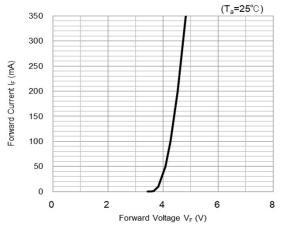




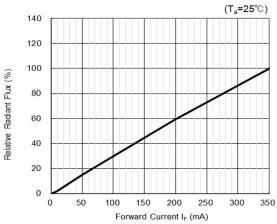
MODEL 325-FL-02-G02

3.5 x 3.5mm Metal Sealed SMD Hemispherical Lens Type Reference Data(1)

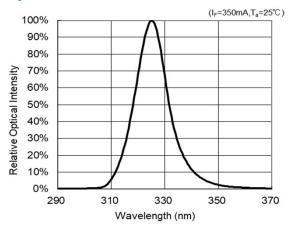
Forward Voltage vs Forward Current



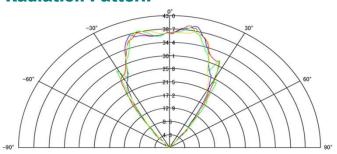
Forward Current vs Radiant Flux

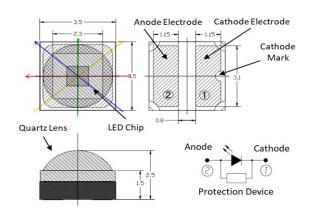


Spectrum



Radiation Pattern







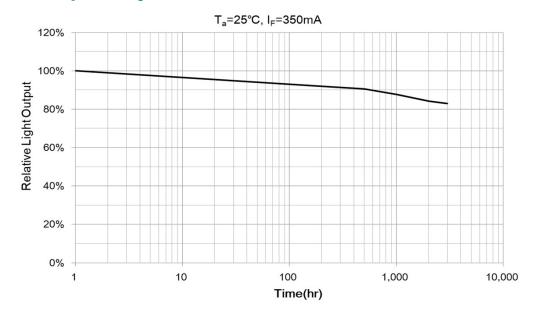




MODEL 325-FL-02-G02

3.5 x 3.5mm Metal Sealed SMD Hemispherical Lens Type Reference Data(2)

Life Expectancy Data



These data as on the page 1 to 4 were determined with Al-substrate on a heat sink and fan.